



NOTES:

1. Dimensions are in inches [mm].
2. Recommended PCB hole diameter for pins: 0.050 [1.27].
4. 2oz. copper over 600V dielectric over aluminum substrate.
5. Tin over nickel plated phospher bronze pins.
6. It is not recommended that mounting of the package rely on the pins for mechanical support.
7. Use #4 or equivalent screws to mount to heat sink.
8. Package Weight: 35 grams.

TOLERANCES - UNLESS OTHERWISE SPECIFIED
.XX = +/- .05" [1.254]
.XXX = +/- .005" [1.27]
ANG. = +/- 2 DEGREES



TITLE: 30-PIN MODULAR DIP, 3.0" SPACING			
SUBJECT: PACKAGE OUTLINE			
ENGINEER: AA	DRAWN BY: EAS	DCA: 19046	SH. OF 1 1

MODEL: KP	
FILENAME: KP	REV: A
DATE: 13FEB19	